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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Obsolete
Core Processor	MIPS32® M4K™
Core Size	32-Bit Single-Core
Speed	50MHz
Connectivity	I ² C, IrDA, LINbus, PMP, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, I ² S, POR, PWM, WDT
Number of I/O	25
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	32K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 3.6V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	36-VFTLA Exposed Pad
Supplier Device Package	36-VTLA (5x5)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mx150f128c-50i-tl

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Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

TABLE 5: PIN NAMES FOR 28-PIN GENERAL PURPOSE DEVICES

28-PIN QFN (TOP VIEW)^(1,2,3.4)

PIC32MX110F016B PIC32MX120F032B PIC32MX130F064B PIC32MX130F256B PIC32MX150F128B PIC32MX170F256B

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1

Pin #	Full Pin Name	Pin #	Full Pin Name
1	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/RB0	15	TDO/RPB9/SDA1/CTED4/PMD3/RB9
2	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/RB1	16	Vss
3	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/RB2	17	VCAP
4	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/RB3	18	PGED2/RPB10/CTED11/PMD2/RB10
5	Vss	19	PGEC2/TMS/RPB11/PMD1/RB11
6	OSC1/CLKI/RPA2/RA2	20	AN12/PMD0/RB12
7	OSC2/CLKO/RPA3/PMA0/RA3	21	AN11/RPB13/CTPLS/PMRD/RB13
8	SOSCI/RPB4/RB4	22	CVREFOUT/AN10/C3INB/RPB14/SCK1/CTED5/PMWR/RB14
9	SOSCO/RPA4/T1CK/CTED9/PMA1/RA4	23	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15
10	Vdd	24	AVss
11	PGED3/RPB5/PMD7/RB5	25	AVdd
12	PGEC3/RPB6/PMD6/RB6	26	MCLR
13	TDI/RPB7/CTED3/PMD5/INT0/RB7	27	VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/RA0
14	TCK/RPB8/SCL1/CTED10/PMD4/RB8	28	VREF-/CVREF-/AN1/RPA1/CTED2/RA1
Note	1: The RPn pins can be used by remappable peripherals. See T	able 1 for th	e available peripherals and Section 11.3 "Peripheral Pin

1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin Select" for restrictions.

2: Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information.

3: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally.

4: Shaded pins are 5V tolerant.

TABLE 7: PIN NAMES FOR 36-PIN GENERAL PURPOSE DEVICES

36-PIN VTLA (TOP VIEW)^(1,2,3,5)

PIC32MX110F016C PIC32MX120F032C PIC32MX130F064C PIC32MX150F128C

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Pin #	Full Pin Name	Pin #	Full Pin Name
1	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/RB2	19	TDO/RPB9/SDA1/CTED4/PMD3/RB9
2	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/RB3	20	RPC9/CTED7/RC9
3	PGED4 ⁽⁴⁾ /AN6/RPC0/RC0	21	Vss
4	PGEC4 ⁽⁴⁾ /AN7/RPC1/RC1	22	VCAP
5	VDD	23	VDD
6	Vss	24	PGED2/RPB10/CTED11/PMD2/RB10
7	OSC1/CLKI/RPA2/RA2	25	PGEC2/TMS/RPB11/PMD1/RB11
8	OSC2/CLKO/RPA3/PMA0/RA3	26	AN12/PMD0/RB12
9	SOSCI/RPB4/RB4	27	AN11/RPB13/CTPLS/PMRD/RB13
10	SOSCO/RPA4/T1CK/CTED9/PMA1/RA4	28	CVREFOUT/AN10/C3INB/RPB14/SCK1/CTED5/PMWR/RB14
11	RPC3/RC3	29	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15
12	Vss	30	AVss
13	VDD	31	AVdd
14	VDD	32	MCLR
15	PGED3/RPB5/PMD7/RB5	33	VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/RA0
16	PGEC3/RPB6/PMD6/RB6	34	VREF-/CVREF-/AN1/RPA1/CTED2/RA1
17	TDI/RPB7/CTED3/PMD5/INT0/RB7	35	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/RB0
18	TCK/RPB8/SCL1/CTED10/PMD4/RB8	36	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/RB1

Note 1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin Select" for restrictions.

2: Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information.

3: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally.

4: This pin function is not available on PIC32MX110F016C and PIC32MX120F032C devices.

5: Shaded pins are 5V tolerant.

TABLE 8: **PIN NAMES FOR 36-PIN USB DEVICES**

36-PIN VTLA (TOP VIEW)^(1,2,3,5)

PIC32MX210F016C

	PIC32MX220F032C PIC32MX230F064C PIC32MX250F128C		
			36
			1
Pin #	Full Pin Name	Pin #	Full Pin Name
1	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/PMD2/RB2	19	TDO/RPB9/SDA1/CTED4/PMD3/RB9
2	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/PMWR/RB3	20	RPC9/CTED7/RC9
3	PGED4 ⁽⁴⁾ /AN6/RPC0/RC0	21	Vss
4	PGEC4 ⁽⁴⁾ /AN7/RPC1/RC1	22	VCAP
5	VDD	23	Vdd
6	Vss	24	PGED2/RPB10/D+/CTED11/RB10
7	OSC1/CLKI/RPA2/RA2	25	PGEC2/RPB11/D-/RB11
8	OSC2/CLKO/RPA3/PMA0/RA3	26	VUSB3V3
9	SOSCI/RPB4/RB4	27	AN11/RPB13/CTPLS/PMRD/RB13
10	SOSCO/RPA4/T1CK/CTED9/PMA1/RA4	28	CVREFOUT/AN10/C3INB/RPB14/VBUSON/SCK1/CTED5/RB14
11	AN12/RPC3/RC3	29	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15
12	Vss	30	AVss
13	DD	31	AVdd
14	DD	32	MCLR
15	TMS/RPB5/USBID/RB5	33	PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0
16	VBUS	34	PGEC3/VREF-/CVREF-/AN1/RPA1/CTED2/PMD6/RA1
17	TDI/RPB7/CTED3/PMD5/INT0/RB7	35	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/PMD0/RB0
18	TCK/RPB8/SCL1/CTED10/PMD4/RB8	36	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/PMD1/RB1
		L	

Note The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin 1: Select" for restrictions.

Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information. 2:

The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally. 3:

4: This pin function is not available on PIC32MX210F016C and PIC32MX120F032C devices.

5: Shaded pins are 5V tolerant.

TABLE 9: PIN NAMES FOR 44-PIN GENERAL PURPOSE DEVICES

44-PIN QFN (TOP VIEW)^(1,2,3,5)

PIC32MX110F016D PIC32MX120F032D PIC32MX130F064D PIC32MX130F256D PIC32MX150F128D PIC32MX170F256D

Pin #	Full Pin Name	Pin #	Full Pin Name
1	RPB9/SDA1/CTED4/PMD3/RB9	23	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/RB2
2	RPC6/PMA1/RC6	24	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/RB3
3	RPC7/PMA0/RC7	25	AN6/RPC0/RC0
4	RPC8/PMA5/RC8	26	AN7/RPC1/RC1
5	RPC9/CTED7/PMA6/RC9	27	AN8/RPC2/PMA2/RC2
6	Vss	28	Vdd
7	VCAP	29	Vss
8	PGED2/RPB10/CTED11/PMD2/RB10	30	OSC1/CLKI/RPA2/RA2
9	PGEC2/RPB11/PMD1/RB11	31	OSC2/CLKO/RPA3/RA3
10	AN12/PMD0/RB12	32	TDO/RPA8/PMA8/RA8
11	AN11/RPB13/CTPLS/PMRD/RB13	33	SOSCI/RPB4/RB4
12	PGED4 ⁽⁴⁾ /TMS/PMA10/RA10	34	SOSCO/RPA4/T1CK/CTED9/RA4
13	PGEC4 ⁽⁴⁾ /TCK/CTED8/PMA7/RA7	35	TDI/RPA9/PMA9/RA9
14	CVREFOUT/AN10/C3INB/RPB14/SCK1/CTED5/PMWR/RB14	36	RPC3/RC3
15	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15	37	RPC4/PMA4/RC4
16	AVss	38	RPC5/PMA3/RC5
17	AVDD	39	Vss
18	MCLR	40	Vdd
19	VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/RA0	41	PGED3/RPB5/PMD7/RB5
20	VREF-/CVREF-/AN1/RPA1/CTED2/RA1	42	PGEC3/RPB6/PMD6/RB6
21	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/RB0	43	RPB7/CTED3/PMD5/INT0/RB7
22	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/RB1	44	RPB8/SCL1/CTED10/PMD4/RB8

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Note 1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin Select" for restrictions.

2: Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information.

3: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally.

4: This pin function is not available on PIC32MX110F016D and PIC32MX120F032D devices.

5: Shaded pins are 5V tolerant.

	Pin Number ⁽¹⁾							
Pin Name	28-pin QFN	28-pin SSOP/ SPDIP/ SOIC	36-pin VTLA	44-pin QFN/ TQFP/ VTLA	Pin Type	Buffer Type	Description	
PMA0	7	10	8	3	I/O	TTL/ST	Parallel Master Port Address bit 0 input (Buffered Slave modes) and output (Master modes)	
PMA1	9	12	10	2	I/O	TTL/ST	Parallel Master Port Address bit 1 input (Buffered Slave modes) and output (Master modes)	
PMA2		_	_	27	0	_	Parallel Master Port address	
PMA3				38	0	—	(Demultiplexed Master modes)	
PMA4				37	0	—		
PMA5		_	_	4	0	_		
PMA6		_	_	5	0	_		
PMA7				13	0	—		
PMA8		_	_	32	0	_		
PMA9		_	_	35	0	_		
PMA10		_	_	12	0	_		
PMCS1	23	26	29	15	0	_	Parallel Master Port Chip Select 1 strobe	
PMD0	20 ⁽²⁾	23 ⁽²⁾	26 ⁽²⁾	10 ⁽²⁾	1/0	TTI /CT	Parallel Master Port data (Demultiplexed	
	1 ⁽³⁾	4 ⁽³⁾	35 ⁽³⁾	21 ⁽³⁾	1/0	111/31	Master mode) or address/data	
	19 (2)	22 ⁽²⁾	25 ⁽²⁾	9(2)	1/0	TTL/ST	(Multiplexed Master modes)	
	2 ⁽³⁾	5 ⁽³⁾	36 ⁽³⁾	22 ⁽³⁾	1/0			
	18 ⁽²⁾	21 ⁽²⁾	24 ⁽²⁾	8 ⁽²⁾	1/0	TTI /ST		
	ვ(3)	6 ⁽³⁾	1 ⁽³⁾	23 ⁽³⁾	1/0	116/01		
PMD3	15	18	19	1	I/O	TTL/ST		
PMD4	14	17	18	44	I/O	TTL/ST		
PMD5	13	16	17	43	I/O	TTL/ST		
PMD6	12 ⁽²⁾	15 ⁽²⁾	16 ⁽²⁾	42 ⁽²⁾	1/0	TTI /CT	1	
	28 ⁽³⁾	3(3)	34 (3)	20 ⁽³⁾	1/0	111/31		
PMD7	11(2)	14 ⁽²⁾	15 (2)	41 ⁽²⁾	1/0	TTI /ST		
	27 ⁽³⁾	2 ⁽³⁾	33 (3)	19 ⁽³⁾	1/0	112/01		
PMRD	21	24	27	11	0	—	Parallel Master Port read strobe	
	22 ⁽²⁾	25 ⁽²⁾	28 ⁽²⁾	14 ⁽²⁾	0		Parallel Master Port write strope	
	4 ⁽³⁾	7 ⁽³⁾	2 ⁽³⁾	24 ⁽³⁾	Ŭ		T arallel master Fort while strobe	
VBUS	12 ⁽³⁾	15 ⁽³⁾	16 (3)	42 ⁽³⁾	Ι	Analog	USB bus power monitor	
VUSB3V3	20 ⁽³⁾	23 ⁽³⁾	26 ⁽³⁾	10 ⁽³⁾	Р	_	USB internal transceiver supply. This pin must be connected to VDD.	
VBUSON	22 ⁽³⁾	25 ⁽³⁾	28 ⁽³⁾	14 ⁽³⁾	0		USB Host and OTG bus power control output	
D+	18 ⁽³⁾	21 ⁽³⁾	24 ⁽³⁾	8 ⁽³⁾	I/O	Analog	USB D+	
D-	19 ⁽³⁾	22 ⁽³⁾	25 ⁽³⁾	9(3)	I/O	Analog	USB D-	
Legend:	CMOS = C	MOS compa	atible input	or output		Analog =	Analog input P = Power	
	ST = Schmi	tt Trigger in	put with CN	NOS levels		O = Outp	but I=Input	
	TTL = TTL input buffer					PPS = P	eripheral Pin Select — = N/A	

Note 1: Pin numbers are provided for reference only. See the "Pin Diagrams" section for device pin availability.

2: Pin number for PIC32MX1XX devices only.

3: Pin number for PIC32MX2XX devices only.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
24.24	R	R	R	R	R	R	R	R	
31:24	BMXDRMSZ<31:24>								
00.40	R	R	R	R	R	R	R	R	
23:10	BMXDRMSZ<23:16>								
45.0	R	R	R	R	R	R	R	R	
15:8	BMXDRMSZ<15:8>								
7:0	R	R	R	R	R	R	R	R	
				BMXDR	MSZ<7:0>				

BMXDRMSZ: DATA RAM SIZE REGISTER REGISTER 4-5:

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-0 BMXDRMSZ<31:0>: Data RAM Memory (DRM) Size bits

Static value that indicates the size of the Data RAM in bytes: 0x00001000 = Device has 4 KB RAM 0x00002000 = Device has 8 KB RAM 0x00004000 = Device has 16 KB RAM 0x00008000 = Device has 32 KB RAM 0x00010000 = Device has 64 KB RAM

REGISTER 4-6: BMXPUPBA: PROGRAM FLASH (PFM) USER PROGRAM BASE ADDRESS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0		
	—	—	—	—	—	—	—	—		
	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0		
23:16	_	_	_	—		BMXPUPBA<19:16>				
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0	R-0		
15:8	BMXPUPBA<15:8>									
7:0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0		
			BMXPUPBA<7:0>							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-20 Unimplemented: Read as '0'

bit 19-11 BMXPUPBA<19:11>: Program Flash (PFM) User Program Base Address bits

bit 10-0 BMXPUPBA<10:0>: Read-Only bits This value is always '0', which forces 2 KB increments

Note 1: At Reset, the value in this register is forced to zero, which causes all of the RAM to be allocated to Kernal mode data usage.

2: The value in this register must be less than or equal to BMXPFMSZ.

FIGURE 8-1: OSCILLATOR DIAGRAM



 Refer to Section 6. "Oscillator Configuration" (DS60001112) in the "PIC32 Family Reference Manual" for help in determinin best oscillator components.

3. The PBCLK out is only available on the OSC2 pin in certain clock modes.

4. The USB PLL is only available on PIC32MX2XX devices.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
21.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	—	—	—	—	—	—	—	—
22:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	—	—	—	—	—	—	—	—
15.0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15.0	—	—	—	—	—	—	—	—
7:0	R-x	R-x	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	JSTATE	JSTATE SE0	PKTDIS ⁽⁴⁾		HOSTEN ⁽²⁾	OSTEN ⁽²⁾ RESUME ⁽³⁾	DDBDST	USBEN ⁽⁴⁾
			TOKBUSY ^(1,5)	000001			PPDROI	SOFEN ⁽⁵⁾

REGISTER 10-11: U1CON: USB CONTROL REGISTER

Legend:

3					
R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 31-8 Unimplemented: Read as '0'

- bit 7 **JSTATE:** Live Differential Receiver JSTATE flag bit 1 = JSTATE was detected on the USB
 - 0 = No JSTATE was detected on the
- bit 6 **SE0:** Live Single-Ended Zero flag bit 1 = Single-Ended Zero was detected on the USB
 - 0 = No Single-Ended Zero was detected
- bit 5 **PKTDIS:** Packet Transfer Disable bit⁽⁴⁾
 - 1 = Token and packet processing is disabled (set upon SETUP token received)
 - 0 = Token and packet processing is enabled
 - TOKBUSY: Token Busy Indicator bit^(1,5)
 - 1 = Token is being executed by the USB module
 - 0 = No token is being executed

bit 4 USBRST: Module Reset bit⁽⁵⁾

- 1 = USB reset generated
- 0 = USB reset terminated
- bit 3 HOSTEN: Host Mode Enable bit⁽²⁾
 - 1 = USB host capability is enabled
 - 0 = USB host capability is disabled
- bit 2 RESUME: RESUME Signaling Enable bit⁽³⁾
 - 1 = RESUME signaling is activated
 - 0 = RESUME signaling is disabled
- **Note 1:** Software is required to check this bit before issuing another token command to the U1TOK register (see Register 10-15).
 - 2: All host control logic is reset any time that the value of this bit is toggled.
 - 3: Software must set RESUME for 10 ms if the part is a function, or for 25 ms if the part is a host, and then clear it to enable remote wake-up. In Host mode, the USB module will append a Low-Speed EOP to the RESUME signaling when this bit is cleared.
 - 4: Device mode.
 - 5: Host mode.

IABL	E 11-7:	PE	RIPHER		I SELEC			GISTER	(WIAP (CONTIN	NUED)								
SS										В	its								
Virtual Addre (BF80_#)	Register Name	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets
FB4C	RPB8R	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—		0000
	-	15:0	_	—	-	-	-	-	-	—	—	—	-	-		RPB8	<3:0>		0000
FB50	RPB9R	31:16	_	_	—					—	—	—			_			—	0000
		15:0		—	—	—	—	_	—		—	—	—	—		RPB9	<3:0>		0000
FB54	RPB10R	31:16	—	—	—	—	—	—	—				—	—	—	—		—	0000
	1. 5101	15:0	—	—	—	—	—	—	—				—	—		RPB1	0<3:0>		0000
FB58	RPB11R	31:16	—	—	—	—	—	—	—				—	—	—	—		—	0000
. 200		15:0	—	—	—	—	—	—	—				—	—		RPB1 ²	1<3:0>		0000
FB60	RPB13R	31:16	_	—	—	-	—	-	-	—	—	—	-	-	—	—	—	—	0000
1 200		15:0	_	—	—	-	—	-	-	—	—	—	-	-		RPB1	3<3:0>		0000
FB64	RPR14R	31:16	_	—	—	—	—	—	—	—	_	—	—	—	_	—		—	0000
1 004		15:0	_	—	—	—	—	—	—	—	_	—	—	—		RPB14	4<3:0>		0000
FB68	RPR15R	31:16	_	—	—	—	—	—	—	—	_	—	—	—	_	—		—	0000
1 800	IN DION	15:0	_	—	—	—	—	—	—	—	_	—	—	—		RPB1	5<3:0>		0000
FRAC		31:16		—	—	—	—	—	—	—	—	—	—	—	_	—	—	—	0000
T DOC		15:0		—	—	—	—	—	—	—	—	—	—	—		RPC0	<3:0>		0000
EB70		31:16		—	—	—	—	—	—	—	—	—	—	—	_	—	—	—	0000
1 870	KFUIK [®]	15:0	-	—	—	—	—	—	—	—	—	—	—	—		RPC1	<3:0>		0000
ED74	DDC2D(1)	31:16	-	—	—	—	—	—	—	—	—	—	—	—	-	—	_	—	0000
10/4	KF 02K ¹	15:0	-	—	—	—	—	—	—	—	—	—	—	—		RPC2	<3:0>		0000
ED79		31:16	-	—	—	—	—	—	—	—	—	—	—	—	-	—	_	—	0000
1 0/0	KF CJK	15:0	-	—	—	—	—	—	—	—	—	—	—	—		RPC3	<3:0>		0000
EBTC		31:16	-	—	—	—	—	—	—	—	—	—	—	—	-	—	_	—	0000
FB/C		15:0		—	—	—	—	—	—	—	—	—	—	—		RPC4	<3:0>		0000
		31:16	-	—	-	-	-	-	-	-	—	—	-	-	-	—	—	—	0000
F BOU	KFC0K"	15:0		—	—	—	—	—	—	—	—	—	—	—		RPC5	i<3:0>		0000
	DDCcD(1)	31:16	_	_	—	_	—	—	—	_	_	_	—	_	_	_	_	_	0000
гв04	RPUOK	15:0	_	_	—	_	—	_	—	_	—	_	—	_		RPC6	i<3:0>		0000
EDOO		31:16	_	_	—	_	—	_	—	_	—	_	_	_	_	—	—	—	0000
FB98	KPU/K"	15:0	_	_	_	_	_	_	_	_	_	_	_	_		RPC7	<3:0>		0000

OT AUTOUT DEALATED MAD

x = unknown value on Reset; - = unimplemented, read as '0'. Reset values are shown in hexadecimal. Legend:

This register is only available on 44-pin devices. Note 1:

2: 3:

This register is only available on PIC32MX1XX devices. This register is only available on 36-pin and 44-pin devices.

18.1 I2C Control Registers

TABLE 18-1: I2C1 AND I2C2 REGISTER MAP

ess										Bi	ts								
Virtual Addr (BF80_#)	Register Name ⁽¹⁾	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets
5000	1201000	31:16	_	_		_	_	-	_	_	_	_	_	_		_	_		0000
5000	12CTCON	15:0	ON	—	SIDL	SCLREL	STRICT	A10M	DISSLW	SMEN	GCEN	STREN	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	1000
5010		31:16	_	_		—	_		—	_	_	_	_	_	-	_	_	-	0000
3010	120131AI	15:0	ACKSTAT	TRSTAT		—	_	BCL	GCSTAT	ADD10	IWCOL	I2COV	D_A	Р	S	R_W	RBF	TBF	0000
5020		31:16	—	—	_		—			—	_				_	—	—	—	0000
0020	12017188	15:0	—	—	—	—	—	—					Address	Register					0000
5030	I2C1MSK	31:16	—	_	_	—	—			—	_	—	—	—	—	_	—	—	0000
		15:0	_	_			_						Address Ma	ask Register					0000
5040	I2C1BRG	31:16	_	—	_	-	—	_	—	—			—	—	—	—	—	—	0000
		15:0	—	_	_	—					Bau	id Rate Ger	erator Reg	ister					0000
5050	I2C1TRN	31:16	_	_	—	—	—	—	—	_	_	—	—	_		_	—	_	0000
		15:0	_	—	_		—			_				Transmit	Register				0000
5060	I2C1RCV	31:16		_			_			_		_	_				—		0000
		15:0		_			_			_				Receive	Register				0000
5100	I2C2CON	31:16	_	_	-	-	-	—	—	-	-	-	-	-	-		-	-	0000
		15:0	ON	_	SIDL	SCLREL	STRICT	A10M	DISSLW	SMEN	GCEN	STREN	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	1000
5110	I2C2STAT	31.10					_								-				0000
		15.0	ACKSTAT	IRSIAI				BUL	GCSTAT	ADD IU	IWCOL	12000	A	P	3	K_W	RDF	IBF	0000
5120	I2C2ADD	15.0							_	_	_	_		— Pogistor	_	_	_	_	0000
		31.16					_						Address	Keyistei	_				0000
5130	I2C2MSK	15.0		_		<u> </u>	_		1				Address Ma	l Isk Register					0000
		31:16	_	_		_			_	_	_		_		_	_	_	_	0000
5140	I2C2BRG	15:0	_	_	_	_					Bau	id Rate Ger	erator Reg	ister					0000
		31:16	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	0000
5150	I2C2TRN	15:0	_	_	_	_	_	_	_	_				Transmit	Register				0000
		31:16	_	_	_	_	_	_	_	_	_	—	—	_	_	_	_	_	0000
5160	I2C2RCV	15:0	_	_	_	_	_	_	_	_				Receive	Register				0000
Legen	d : x = u	nknow	n value on l	Reset: — =		ented, read	as '0'. Rese	t values are	e shown in h	exadecima					-				

x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

All registers in this table except I2CxRCV have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "CLR, SET and INV Registers" for more information. Note 1:

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
31:24	—	—	—	—	—	—	CAL<9):8>
22:16	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
23.10				CAL<	:7:0>			
45.0	R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
15:8	ON ^(1,2)	—	SIDL	_	—	—	—	—
7.0	R/W-0	R-0	U-0	U-0	R/W-0	R-0	R-0	R/W-0
7:0	RTSECSEL ⁽³⁾	RTCCLKON	—	—	RTCWREN ⁽⁴⁾	RTCSYNC	HALFSEC ⁽⁵⁾	RTCOE

REGISTER 21-1: RTCCON: RTC CONTROL REGISTER

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	ad as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-26 Unimplemented: Read as '0'

bit 25-16 CAL<9:0>: RTC Drift Calibration bits, which contain a signed 10-bit integer value 0111111111 = Maximum positive adjustment, adds 511 RTC clock pulses every one minute 000000001 = Minimum positive adjustment, adds 1 RTC clock pulse every one minute 000000000 = No adjustment 1111111111 = Minimum negative adjustment, subtracts 1 RTC clock pulse every one minute 100000000 = Maximum negative adjustment, subtracts 512 clock pulses every one minute ON: RTCC On bit^(1,2) bit 15 1 = RTCC module is enabled 0 = RTCC module is disabled bit 14 Unimplemented: Read as '0' bit 13 SIDL: Stop in Idle Mode bit 1 = Disables the PBCLK to the RTCC when the device enters Idle mode 0 = Continue normal operation when the device enters Idle mode bit 12-8 Unimplemented: Read as '0' bit 7 RTSECSEL: RTCC Seconds Clock Output Select bit⁽³⁾ 1 = RTCC Seconds Clock is selected for the RTCC pin 0 = RTCC Alarm Pulse is selected for the RTCC pin bit 6 RTCCLKON: RTCC Clock Enable Status bit 1 = RTCC Clock is actively running 0 = RTCC Clock is not running **Note 1:** The ON bit is only writable when RTCWREN = 1. 2: When using the 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit. 3: Requires RTCOE = 1 (RTCCON<0>) for the output to be active. 4: The RTCWREN bit can be set only when the write sequence is enabled. 5: This bit is read-only. It is cleared to '0' on a write to the seconds bit fields (RTCTIME<14:8>).

Note: This register is reset only on a Power-on Reset (POR).

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REGISTER 21-1: RTCCON: RTC CONTROL REGISTER (CONTINUED)

- bit 5-4 **Unimplemented:** Read as '0'
- bit 3 RTCWREN: RTC Value Registers Write Enable bit⁽⁴⁾
 - 1 = RTC Value registers can be written to by the user
 - 0 = RTC Value registers are locked out from being written to by the user
- bit 2 RTCSYNC: RTCC Value Registers Read Synchronization bit
 - 1 = RTC Value registers can change while reading, due to a rollover ripple that results in an invalid data read
 If the register is read twice and results in the same data, the data can be assumed to be valid
 - 0 = RTC Value registers can be read without concern about a rollover ripple
- bit 1 HALFSEC: Half-Second Status bit⁽⁵⁾
 - 1 = Second half period of a second
 - 0 = First half period of a second
- bit 0 **RTCOE:** RTCC Output Enable bit
 - 1 = RTCC clock output enabled clock presented onto an I/O
 - 0 = RTCC clock output disabled
- **Note 1:** The ON bit is only writable when RTCWREN = 1.
 - 2: When using the 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.
 - **3:** Requires RTCOE = 1 (RTCCON<0>) for the output to be active.
 - 4: The RTCWREN bit can be set only when the write sequence is enabled.
 - 5: This bit is read-only. It is cleared to '0' on a write to the seconds bit fields (RTCTIME<14:8>).

Note: This register is reset only on a Power-on Reset (POR).

25.0 CHARGE TIME MEASUREMENT UNIT (CTMU)

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 37. "Charge Time Measurement Unit (CTMU)" (DS60001167), which is available from the Documentation > Reference Manual section of the Microchip PIC32 web site (www.microchip.com/pic32).

The Charge Time Measurement Unit (CTMU) is a flexible analog module that has a configurable current source with a digital configuration circuit built around it. The CTMU can be used for differential time measurement between pulse sources and can be used for generating an asynchronous pulse. By working with other on-chip analog modules, the CTMU can be used for high resolution time measurement, measure capacitance, measure relative changes in capacitance or generate output pulses with a specific time delay. The CTMU is ideal for interfacing with capacitive-based sensors.



- Up to 13 channels available for capacitive or time measurement input
- · On-chip precision current source
- 16-edge input trigger sources
- · Selection of edge or level-sensitive inputs
- · Polarity control for each edge source
- Control of edge sequence
- Control of response to edges
- · High precision time measurement
- Time delay of external or internal signal asynchronous to system clock
- · Integrated temperature sensing diode
- · Control of current source during auto-sampling
- · Four current source ranges
- · Time measurement resolution of one nanosecond

A block diagram of the CTMU is shown in Figure 25-1.



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NOTES:

The processor will exit, or 'wake-up', from Sleep on one of the following events:

- On any interrupt from an enabled source that is operating in Sleep. The interrupt priority must be greater than the current CPU priority.
- · On any form of device Reset
- On a WDT time-out

If the interrupt priority is lower than or equal to the current priority, the CPU will remain Halted, but the PBCLK will start running and the device will enter into Idle mode.

26.3.2 IDLE MODE

In Idle mode, the CPU is Halted but the System Clock (SYSCLK) source is still enabled. This allows peripherals to continue operation when the CPU is Halted. Peripherals can be individually configured to Halt when entering Idle by setting their respective SIDL bit. Latency, when exiting Idle mode, is very low due to the CPU oscillator source remaining active.

- Note 1: Changing the PBCLK divider ratio requires recalculation of peripheral timing. For example, assume the UART is configured for 9600 baud with a PB clock ratio of 1:1 and a Posc of 8 MHz. When the PB clock divisor of 1:2 is used, the input frequency to the baud clock is cut in half; therefore, the baud rate is reduced to 1/2 its former value. Due to numeric truncation in calculations (such as the baud rate divisor), the actual baud rate may be a tiny percentage different than expected. For this reason, any timing calculation required for a peripheral should be performed with the new PB clock frequency instead of scaling the previous value based on a change in the PB divisor ratio.
 - 2: Oscillator start-up and PLL lock delays are applied when switching to a clock source that was disabled and that uses a crystal and/or the PLL. For example, assume the clock source is switched from Posc to LPRC just prior to entering Sleep in order to save power. No oscillator startup delay would be applied when exiting Idle. However, when switching back to Posc, the appropriate PLL and/or oscillator start-up/lock delays would be applied.

The device enters Idle mode when the SLPEN (OSCCON<4>) bit is clear and a WAIT instruction is executed.

The processor will wake or exit from Idle mode on the following events:

- On any interrupt event for which the interrupt source is enabled. The priority of the interrupt event must be greater than the current priority of the CPU. If the priority of the interrupt event is lower than or equal to current priority of the CPU, the CPU will remain Halted and the device will remain in Idle mode.
- On any form of device Reset
- On a WDT time-out interrupt

26.3.3 PERIPHERAL BUS SCALING METHOD

Most of the peripherals on the device are clocked using the PBCLK. The Peripheral Bus can be scaled relative to the SYSCLK to minimize the dynamic power consumed by the peripherals. The PBCLK divisor is controlled by PBDIV<1:0> (OSCCON<20:19>), allowing SYSCLK to PBCLK ratios of 1:1, 1:2, 1:4 and 1:8. All peripherals using PBCLK are affected when the divisor is changed. Peripherals such as the USB, Interrupt Controller, DMA, and the bus matrix are clocked directly from SYSCLK. As a result, they are not affected by PBCLK divisor changes.

Changing the PBCLK divisor affects:

- The CPU to peripheral access latency. The CPU has to wait for next PBCLK edge for a read to complete. In 1:8 mode, this results in a latency of one to seven SYSCLKs.
- The power consumption of the peripherals. Power consumption is directly proportional to the frequency at which the peripherals are clocked. The greater the divisor, the lower the power consumed by the peripherals.

To minimize dynamic power, the PB divisor should be chosen to run the peripherals at the lowest frequency that provides acceptable system performance. When selecting a PBCLK divider, peripheral clock requirements, such as baud rate accuracy, should be taken into account. For example, the UART peripheral may not be able to achieve all baud rate values at some PBCLK divider depending on the SYSCLK value.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	r-1	r-1	r-1	r-1	r-1	r-1	r-1	r-1
31:24	—	—	—	—	—	—	—	—
00.40	r-1	r-1	r-1	r-1	r-1	R/P	R/P	R/P
23:10	—	—	—	—	—	FI	PLLODIV<2:()>
45.0	R/P	r-1	r-1	r-1	r-1	R/P	R/P	R/P
15:8	UPLLEN ⁽¹⁾	—	—	_	_	UF	PLLIDIV<2:0>	.(1)
7.0	r-1	R/P-1	R/P	R/P-1	r-1	R/P	R/P	R/P
7:0	_	F	PLLMUL<2:0>	•	_	F	PLLIDIV<2:0	>

DEVCFG2: DEVICE CONFIGURATION WORD 2 REGISTER 27-3:

Legend:	r = Reserved bit	P = Programmable bit				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'				
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 31-19 Reserved: Write '1'

bit 15

bit 7

bit 18-16 FPLLODIV<2:0>: Default PLL Output Divisor bits

- 111 = PLL output divided by 256 110 = PLL output divided by 64 101 = PLL output divided by 32 100 = PLL output divided by 16 011 = PLL output divided by 8 010 = PLL output divided by 4 001 = PLL output divided by 2 000 = PLL output divided by 1 UPLLEN: USB PLL Enable bit⁽¹⁾ 1 = Disable and bypass USB PLL 0 = Enable USB PLL bit 14-11 Reserved: Write '1' bit 10-8 UPLLIDIV<2:0>: USB PLL Input Divider bits⁽¹⁾ 111 = 12x divider 110 = 10x divider 101 = 6x divider100 = 5x divider 011 = 4x divider 010 = 3x divider 010 = 3x divider 001 = 2x divider000 = 1x divider Reserved: Write '1'
- bit 6-4 FPLLMUL<2:0>: PLL Multiplier bits
 - 111 = 24x multiplier 110 = 21x multiplier
 - 101 = 20x multiplier
 - 100 = 19x multiplier
 - 011 = 18x multiplier
 - 010 = 17x multiplier
 - 001 = 16x multiplier
 - 000 = 15x multiplier
- bit 3 Reserved: Write '1'

Note 1: This bit is only available on PIC32MX2XX devices.

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0			
04.04	R	R	R	R	R	R	R	R			
31:24		VER<	3:0> (1)		DEVID<27:24> ⁽¹⁾						
00.40	R	R	R	R	R	R	R	R			
23:10	DEVID<23:16> ⁽¹⁾										
45.0	R	R	R	R	R	R	R	R			
15:8				DEVID<	:15:8> (1)						
7.0	R	R	R	R	R	R	R	R			
7:0				DEVID	<7:0>(1)						

REGISTER 27-6: DEVID: DEVICE AND REVISION ID REGISTER

Legend:

Legena.			
R = Readable bit	W = Writable bit	U = Unimplemented bit, re	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-28 VER<3:0>: Revision Identifier bits⁽¹⁾

bit 27-0 DEVID<27:0>: Device ID bits⁽¹⁾

Note 1: See the "*PIC32 Flash Programming Specification*" (DS60001145) for a list of Revision and Device ID values.







TABLE 30-39: PARALLEL MASTER PORT WRITE TIMING REQUIREMENTS

АС СНА		ISTICS	$\begin{array}{l} \mbox{Standard Operating Conditions: 2.3V to 3.6V} \\ \mbox{(unless otherwise stated)} \\ \mbox{Operating temperature} & -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for Industria} \\ & -40^{\circ}C \leq TA \leq +105^{\circ}C \mbox{ for V-temp} \end{array}$							
Param. No.	Symbol	Characteristics ⁽¹⁾	Min.	Тур.	Max.	Units	Conditions			
PM11	Twr	PMWR Pulse Width	_	1 Трв	_	_	_			
PM12	TDVSU	Data Out Valid before PMWR or PMENB goes Inactive (data setup time)	_	2 Трв	_	_	_			
PM13	TDVHOLD	PMWR or PMEMB Invalid to Data Out Invalid (data hold time)	—	1 Трв	—	—	—			

Note 1: These parameters are characterized, but not tested in manufacturing.

TABLE 30-40: OTG ELECTRICAL SPECIFICATIONS

АС СНА	RACTERI	STICS	$\begin{tabular}{ l l l l l l l l l l l l l l l l l l l$						
Param. No.	Symbol	Characteristics ⁽¹⁾	Min.	Тур.	Max.	Units	Conditions		
USB313	VUSB3V3	USB Voltage	3.0	_	3.6	V	Voltage on VUSB3V3 must be in this range for proper USB operation		
USB315	VILUSB	Input Low Voltage for USB Buffer	_	—	0.8	V	—		
USB316	VIHUSB	Input High Voltage for USB Buffer	2.0	—	_	V	—		
USB318	VDIFS	Differential Input Sensitivity	—	_	0.2	V	The difference between D+ and D- must exceed this value while VCM is met		
USB319	VCM	Differential Common Mode Range	0.8	—	2.5	V	—		
USB320	Zout	Driver Output Impedance	28.0	—	44.0	Ω	—		
USB321	Vol	Voltage Output Low	0.0	—	0.3	V	1.425 kΩ load connected to VUSB3V3		
USB322	Vон	Voltage Output High	2.8		3.6	V	1.425 k Ω load connected to ground		



44-Terminal Very Thin Leadless Array Package (TL) – 6x6x0.9 mm Body With Exposed Pad [VTLA]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging





DETAIL A

	Units	N	IILLIMETER	S		
Dimension	Limits	MIN	NOM	MAX		
Number of Pins	N		44	-		
Number of Pins per Side	ND		12			
Number of Pins per Side	NE		10			
Pitch	е		0.50 BSC			
Overall Height	A	0.80	0.90	1.00		
Standoff	A1	0.025	-	0.075		
Overall Width	E		6.00 BSC			
Exposed Pad Width	E2	4.40	4.55	4.70		
Overall Length	D		6.00 BSC	-		
Exposed Pad Length	D2	4.40	4.55	4.70		
Contact Width	b	0.20	0.25	0.30		
Contact Length	L	0.20	0.25	0.30		
Contact-to-Exposed Pad	K	0.20	_	-		

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Package is saw singulated.

3. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-157C Sheet 2 of 2